

Vishay Siliconix

# N-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	40					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00167					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00224					
Q <sub>g</sub> typ. (nC)	130					
I <sub>D</sub> (A)	150 <sup>d</sup>					
Configuration	Single					

#### **FEATURES**

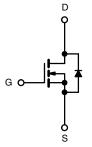
- TrenchFET® power MOSFET
- Maximum 175 °C junction temperature



- Excellent R<sub>DS</sub>-Q<sub>g</sub> and R<sub>DS</sub>-Q<sub>oss</sub> FOM reduce power loss from conduction and switching to enable high efficiency
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Power supply
  - Secondary synchronous rectification
- DC/DC converter
- Power tools
- · Motor drive switch
- · Battery management



N-Channel MOSFET

ORDERING INFORMATION			
Package	TO-263		
Lead (Pb)-free and halogen-free	SUM40012EL-GE3		

ABSOLUTE MAXIMUM RATING	i <b>S</b> (T <sub>C</sub> = 25 °C, unle	ess otherwise noted	d)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	40	.,	
Gate-source voltage		V <sub>GS</sub>	± 20	- V	
Continuous drain current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 25 °C		150 <sup>d</sup>		
Continuous drain current (1 <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	l <sub>D</sub>	150 <sup>d</sup>	1	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	300	A	
Avalanche current		I <sub>AS</sub>	50		
Single avalanche energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	125	mJ	
Maximum power dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	В	150 b	W	
waximum power dissipation "	T <sub>C</sub> = 125 °C	P <sub>D</sub>	50 b	¬	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-ambient (PCB mount) <sup>c</sup>	R <sub>thJA</sub>	40	°C AM		
Junction-to-case (drain)	R <sub>thJC</sub>	1	°C/W		

#### Notes

- a. Duty cycle ≤ 1 %
- b. See SOA curve for voltage derating
- c. When mounted on 1" square PCB (FR4 material)
- d. Package limited

# Vishay Siliconix

<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 ° PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	OTMBOL	1201 CONDITIONS	IVIII V.		Wir O.	O.U.I	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	40	_	_		
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1	-	2.5	V	
Gate-body leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 250	nA	
	000	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	150	μΑ	
G G		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C	-	-	5	mA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	120	-	-	Α	
	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A	-	0.00139	0.00167	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A	-	0.00186	0.00224		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	-	230	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	10 930	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 20 \text{ V}, f = 1 \text{ MHz}$	-	2041	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	101	-		
Total gate charge <sup>c</sup>	Qg		-	130	195		
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	33.6	-		
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>		-	6.7	-	nC	
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V	-	64	96		
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.36	1.8	3.6	Ω	
Turn-on delay time c	t <sub>d(on)</sub>		-	25	50		
Rise time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 2 \Omega$	-	12	24		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	65	130	ns -	
Fall time <sup>c</sup>	t <sub>f</sub>		-	18	36		
Drain-Source Body Diode Ratings	and Characte	ristics <sup>b</sup> (T <sub>C</sub> = 25 °C)		•	•		
Pulsed current (t = 100 μs)	I <sub>SM</sub>		-	-	300	Α	
Forward voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.8	1.5	V	
Reverse recovery time	t <sub>rr</sub>		-	58	116	ns	
Peak reverse recovery charge	I <sub>RM(REC)</sub>		-	2.1	4.2	Α	
Reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	72	144	nC	
Reverse recovery fall time	t <sub>a</sub>		-	32	-	ne	
Reverse recovery rise time	t <sub>b</sub>		-	26	-	ns	

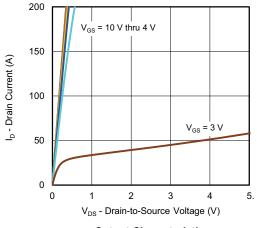
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu\text{s},$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

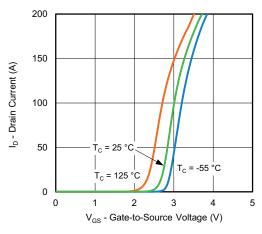
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



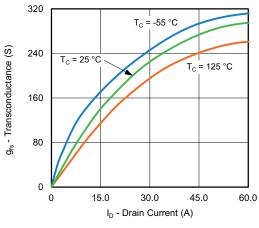
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



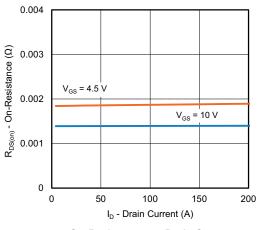
**Output Characteristics** 



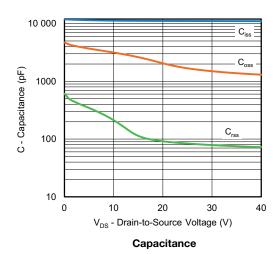
**Transfer Characteristics** 

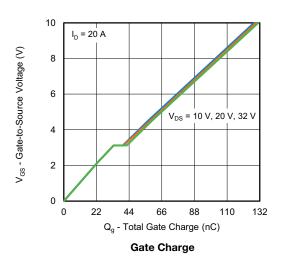


Transconductance



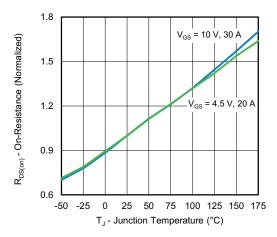
On-Resistance vs. Drain Current



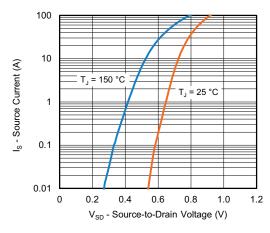




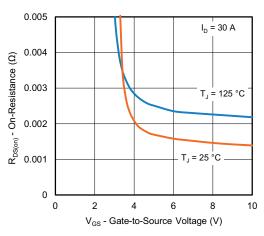
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



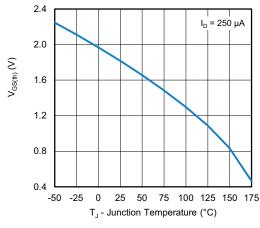
On-Resistance vs. Junction Temperature



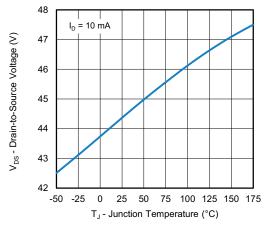
**Source Drain Diode Forward Voltage** 



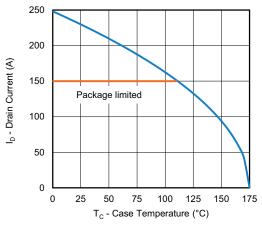
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



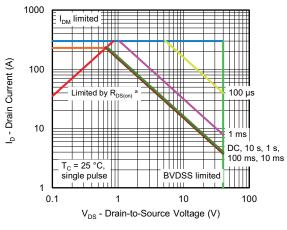
**Drain Source Breakdown vs. Junction Temperature** 

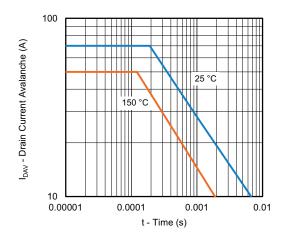


**Current De-rating** 



## THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



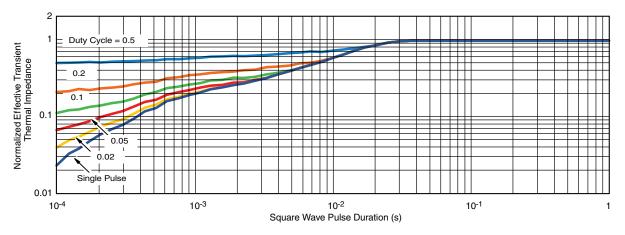


Safe Operating Area

Single Pulse Avalanche Current Capability vs. Time

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



Normalized Thermal Transient Impedance, Junction-to-Case

### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual pplication parameters and operating conditions

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# TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



<u> </u>	b	<b>+</b> +
≥		<u>, o</u>
0	ECTION A	1

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54 BSC		
	K	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4		0.010 BSC		0.254 BSC		
	М	-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

DWG: 5843





## RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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